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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/812,921	03/31/2004	Po-Hung Yau	BHT-3111-444	5691
759	90 05/18/2006	•	EXAMINER	
BRUCE H. TROXELL			NGUYEN, JOSEPH H	
SUITE 1404 5205 LEESBUR	RG PIKE		ART UNIT	PAPER NUMBER
FALLS CHURC			2815	
			DATE MAILED: 05/18/200	6

Please find below and/or attached an Office communication concerning this application or proceeding.

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·	Application No.	Applicant(s)	
<b></b>	10/812,921	YAU ET AL.	
Office Action Summary	Examiner	Art Unit	
	Joseph Nguyen	2815	
The MAILING DATE of this communication Period for Reply	appears on the cover sheet w	ith the correspondence address	
A SHORTENED STATUTORY PERIOD FOR REWHICHEVER IS LONGER, FROM THE MAILIN  - Extensions of time may be available under the provisions of 37 CF after SIX (6) MONTHS from the mailing date of this communicatio  - If NO period for reply is specified above, the maximum statutory properties to reply within the set or extended period for reply will, by some and provided the provided by the Office later than three months after the rearned patent term adjustment. See 37 CFR 1.704(b).	G DATE OF THIS COMMUNI R 1.136(a). In no event, however, may a n. eriod will apply and will expire SIX (6) MON statute, cause the application to become Al	CATION. reply be timely filed  NTHS from the mailing date of this communication BANDONED (35 U.S.C. § 133).	
Status			
1) Responsive to communication(s) filed on	27 February 2006		
,— ,	This action is non-final.	·	
3) Since this application is in condition for all		ters, prosecution as to the merits is	s
closed in accordance with the practice und			
Disposition of Claims			
4)⊠ Claim(s) <u>1,5,8,12,18 and 19</u> is/are pending	n in the application.		
4a) Of the above claim(s) is/are with			
5) Claim(s) is/are allowed.			
6)⊠ Claim(s) <u>1,5,8,12,18 and 19</u> is/are rejected	<b>d</b> .		
7) Claim(s) is/are objected to.			
8) - Claim(s) are subject to restriction a	nd/or election requirement.		
Application Papers			
9) The specification is objected to by the Exa	miner .		
10) ☐ The specification is objected to by the Example 10. ☐ The drawing(s) filed on 31 March 2004 is/a		iected to by the Examiner	
Applicant may not request that any objection to			
Replacement drawing sheet(s) including the co			'd)
11) The oath or declaration is objected to by the			
The dath of declaration is objected to by the			
Priority under 35 U.S.C. § 119	•		
12)⊠ Acknowledgment is made of a claim for for a (a)⊠ All b) Some * c) None of:	eign priority under 35 U.S.C.	§ 119(a)-(d) or (f).	,*
1.⊠ Certified copies of the priority docur	nents have been received.	•	
2. Certified copies of the priority docur		Application No	•
3. Copies of the certified copies of the	priority documents have been		
application from the International Bu		traceived	
* See the attached detailed Office action for a	a list of the certified copies no	r received.	
•			
Attachment(s)			
1) Notice of References Cited (PTO-892)		Summary (PTO-413)	
<ul> <li>2) Notice of Draftsperson's Patent Drawing Review (PTO-94)</li> <li>3) Information Disclosure Statement(s) (PTO-1449 or PTO/S Paper No(s)/Mail Date</li> </ul>	~/	(s)/Mail Date Informal Patent Application (PTO-152)	
S. Patent and Trademark Office		· · · · · · · · · · · · · · · · · · ·	

Application/Control Number: 10/812,921

Art Unit: 2815

#### **DETAILED ACTION**

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1, 5 and 18 are rejected under 35 U.S.C. 103(a) as being unpatentable over Chen (US 6,610,598) in view of Yatsuda et al. (US 2004/0251469).

Regarding claim 1, Chen discloses in figures 6-7 (showing the same embodiment) a planar package structure for higher power light emitting diode comprising a substrate 1; a package material 5; a light emitting diode chip 3 having a main light emitting surface providing a light source (col. 2, lines 11-16); and a planar optical modulation unit 6A comprising a lens and having a plane appearance under the naked eye (col. 3, lines 26-28) disposed on the package material so that the planar optical modulation unit 6A is above the main light emitting surface, and utilized for modulating the optical phase of the light source (col. 2, lines 11-21). Chen does not disclose a light emitting diode chip is in direct contact with the substrate. However, Yatsuda et al. discloses in figure 2 a light emitting diode chip 2 (para [0037], line 7) is in direct contact with the substrate 3a (para [0038], line 1). Note that element 3a is a metal on which the light emitting diode chip 2 is formed. Therefore, element 3B can function as a substrate. In view of such teaching, it would have been obvious at the time of the

Application/Control Number: 10/812,921

Art Unit: 2815

present invention to modify Chen by having a light emitting diode chip being in direct contact with the substrate to effectively dissipate heat away from the LED chip 3 since the LED chip 3 is direct contact with an excellent heat conduction metal 3a (para [0038], lines 1-4, Yatsuda et al.).

Regarding claim 5, Chen discloses in figure 12 a planar modulation unit 6D configured to perform a diffractive optical phase modulation (col. 3, lines 44-49).

Regarding claim 18, the combination of Chen and Yatsuda et al. would include substantially all of a surface of the substrate 3a of Yatsuda et al. underlying the planar optical modulation unit 6a of Chen and being substantially parallel to a surface of the planar optical modulation unit therein.

Claims 8, 12 and 19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Chen (US 6,610,598) and Yatsuda et al. (US 2004/0251469).

Regarding claim 8, similar to claim1 above, Chen (US 6,610,598) and Yatsuda et al. disclose substantially all the structure set forth in claim 8 except the light emitting diode chip and planar optical modulation unit provided in plurality. However, it would have been obvious at the time of the present invention to modify Chen and Yatsuda et al. by having the light emitting diode chip and planar optical modulation unit provided in plurality, since it has been held that mere duplication of the essential parts of a device involves only routine skill in the art. St. Regis Paper Co. v. Bemis Co., 193 USPQ 8.

Regarding claim 12, Chen discloses in figure 12 a planar modulation unit 6D configured to perform a diffractive optical phase modulation (col. 3, lines 44-49).

Application/Control Number: 10/812,921

Art Unit: 2815

Regarding claim 19, the combination of Chen and Yatsuda et al. would include substantially all of a surface of the substrate 3a of Yatsuda et al. underlying the planar optical modulation unit 6a of Chen and being substantially parallel to a surface of the planar optical modulation unit therein.

### Response to Arguments

Applicant's arguments filed on 02/27/2006 have been fully considered but they are not persuasive.

With respect to claims 1 and 8, applicant argues Chen does not teach or suggest a planar optical modulation unit and a light emitting diode chip in direct contact with the substrate. However, Chen clearly discloses in figures 6-7 and in col.3, lines 26-28 element 6a has a lens and a plane appearance under the naked lens disposed on the package material 5. As such, element 6a can be construed as "planar optical modulation unit". Further, as explained in rejection of claims 1 and 8 above, Yatsuda et al. discloses in figure 2 a light emitting diode (LED) chip 2 is in direct contact with substrate 3 formed of a metal such that heat generated in the LED chip can be effectively dissipated since the LED chip is in direct contact with an excellent heat conduction metal 3a (para [0038], lines 1-4, Yatsuda et al.). With such a strong motivation, the combination of Chen and Yatsuda et al. would read on claims 1 and 8. It is also noted in claim 8, having the LED chip and planar optical modulation unit provided in plurality is the mere duplication of the essential parts of a device and involves only routine skill in the art. St. Regis paper Co. vs. Bemis Co. 193. USPQ 8.

With respect to new claims 18 and 19, the combination of Chen and Yatsuda et al. would include substantially all of a surface of the substrate 3a of Yatsuda et al. underlying the planar optical modulation unit 6a of Chen and being substantially parallel to a surface of the planar optical modulation unit therein.

THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Joseph Nguyen whose telephone number is (571) 272-1734. The examiner can normally be reached on Monday-Friday, 7:30 am- 4:30 pm. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Ken Parker can be reached on (571) 272-2298. The fax phone number for

Art Unit: 2815

the organization where this application or proceeding is assigned is (571) 273-8300 for regular communications.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

JN April 26, 2006.

> KENNETH PARKER SUPERVISORY PATENT EXAMINER